

# Xped Limited



## MOU SIGNED WITH ADVANCED SEMICONDUCTOR ENGINEERING

### Highlights

- MOU signed with Advanced Semiconductor Engineering (Taiwan) for licensing of Xped ADRC Technologies
- Proposed agreement allows ASE to incorporate Xped ADRC technologies into their product lines
- ASE are co-listed on NYSE (code: ASX) and TSEC (code: 2311) and are a USD\$8 Billion company with 65000 employees worldwide.
- Trial projects identified in Smart Health and Smart Factory Solutions.

Xped Limited (**ASX: XPE**) (“Xped” or “the Company”) is pleased to announce they have signed a Memorandum of Understanding (“MoU”) with Advanced Semiconductor Engineering Inc (“ASE”) of Taiwan. The companies will now collaboratively engage to develop a binding agreement to license several Xped technologies, develop specific solutions for ASE, and collaboratively market and develop solutions for ASE customer base.

When a binding agreement is reached, ASE will incorporate Xped ADRC Proxy and the RML Translation technology into ASE modules for:

- Automation Devices
- Sensors
- Beacons

Under the proposed terms Xped will provide ASE branded versions of the Xped App customised for:

- Virtual Gateway
- Asset Tracking
- Building Automation
- Smart Factory Solution

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Under the proposed terms, when a binding agreement is reached, the fee will be negotiated from the standard Xped licensing cost sheet:

- Smart Things: USD\$0.15 per Thing
- Smart Gateways: USD\$1.00 per Gateway
- Smart Platform: USD\$2.00 per Platform

In addition, ongoing Maintenance Fees are to be negotiated as part of the final binding agreement.

ASE have identified 3 internal projects as initial trial opportunities. These trials involve Asset Tracking and Smart Factory solutions. Details are being finalised however these will showcase the versatility and functionality of Xped ADRC technologies. Further details will be provided on these projects as they progress.

Now that a Memorandum of Understanding has been signed Xped and ASE will work together to progress to binding agreements. Xped hopes to reach binding agreements for both the trial statements of work and a licensing agreement for ADRC technology with ASE in Q2 2017. An update will be made to the market as soon as progress has been made.

ASE is the world's largest subcontractor of semiconductor back-end manufacturing services. In addition, ASE has developed a tremendous line-up of radio and sensor modules. The key engagement point with Xped will be bringing the ADRC technology to the ASE WiFi, BLE, and 802.15.4 radio modules as well as promoting the ASE sensor modules to our OEM partners.

The next steps for the relationship are to move into binding agreements both in regards to the suggested trials as well as with a licensing agreement for the Xped technology. ASE has the potential to be a direct customer for Xped in their own factories as well as a channel partner who can promote ADRC to their customers. Once the binding agreements have been signed it should take approximately 9 months to see the project reach production.

Xped's Managing Director Martin Despain commented: "This is an exciting opportunity for Xped to work with ASE and demonstrates the attractiveness of our technology solution. The trial projects will provide opportunity to showcase our ADRC solution in both Asset Tracking and in a new market segment of Smart Factories"

Martin Despain  
Managing Director

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## ABOUT XPED

Xped is an Australian Internet of Things (“IoT”) technology business. Xped has developed revolutionary and patent-protected technology that allows any consumer, regardless of their technical capability, to connect, monitor and control devices and appliances found in our everyday environment. It’s as simple as two people shaking hands. By enabling the Internet of Things, Xped’s ADRC platform will bring benefit to Manufacturers, Retailers, Service Providers, and Consumers.

At Xped, we’re **Making Technology Easy Again**

## ABOUT ADVANCED SEMICONDUCTOR ENGINEERING (“ASE GROUP”)

The ASE Group is the world’s largest provider of independent semiconductor manufacturing services in assembly and test. The group develops and offers complete turnkey solutions covering IC packaging, design and production of interconnect materials, front-end engineering test, wafer probing and final test, as well as electronic manufacturing services through USI, Inc. As a global leader, ASE provides a complete scope of services for the semiconductor market, driven by superior technologies, breakthrough innovations, and advanced development programs. The ASE Group is co-listed on NYSE (ASX) and TSEC (2311), has 65000 employees globally and a market capitalisation of approximately USD\$8bn.

[www.aseglobal.com](http://www.aseglobal.com)

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